Product/Process Change Notice - PCN 2436 -

AnalogDevices, Inc. One Analog Way, Wilmington, MA01887, USA

This notice is to inform you of a change that will be made to certain ADI products (see Appendix A) that you may have purchased in the last 2 years. **Any inquiries or requests with this PCN (additional data or samples) must be sent to ADI within 30 days of publication date.**ADI contact information is listed below.

PCN Title:	Addition of UTAC/Singapore/Thailand as an Alternate Bumping/Assembly Site for MAX17793AFN+T Device
Publication Date:	21-Aug-2024
Effectivity Date:	*19-Nov-2024 (the earliest date that a customer could expect to receive changed material)*
Revision Description:	Initial Release.

Description Of Change:

ADI will be adding UTAC/Singapore/Thailand as an alternate bumping/assembly site to Advanced Semiconductor Engineering/Kaohsiung/Taiwan.

Reason For Change:

The addition of UTAC/Singapore/Thailand is to expand capacity, improve cycle time and to ensure supply continuity.

Impact of the change (positive or negative) on fit, form, function & reliability:

There are no changes to the form, fit, function, quality, or reliability of the device.

Product Identification (this section will describe how to identify the changed material):

Analog Devices maintains full traceability by device marking, packaging labels and shipment documents.

Summary of Supporting Information:

Qualification has been performed per Industry Standard Test Methods. See attached Qualification Results Summary.

Supporting Documents:

Attachment 1: Type: Qualification Report Summary

RQR44333B.pdf

ADI Contact Information:

For questions on this PCN, please send an email to the regional contacts below or contact your local ADI sales representatives.

Americas:	Europe:	Japan:	Korea:	Rest of Asia:
PCN_Americas@analog.com	PCN_Europe@analog.com	PCN_Japan@analog.com	PCN_Korea@analog.com	PCN_ROA@analog.com

Appendix A - Impacted items, see csv PN listing in PCN Zip file